

# **RQJ0204XGDQA**

Silicon P Channel MOS FET **Power Switching** 

R07DS0293EJ0400 (Previous: REJ03G1320-0300) Rev.4.00 Mar 28, 2011

#### **Features**

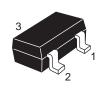
• Low on-resistance

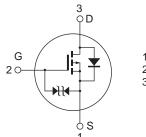
 $R_{DS(on)}$  = 219 m $\Omega$  typ (V  $_{GS}$  = -4.5 V,  $I_D$  = -0.8 A)

- Low drive current
- High speed switching
- 2.5 V gate drive

#### **Outline**

RENESAS Package code: PLSP0003ZB-A (Package name: MPAK)





1. Source

2. Gate 3. Drain

Note: Marking is "XG".

# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	-20	V
Gate to source voltage	V <sub>GSS</sub>	+8 / -12	V
Drain current	I <sub>D</sub>	-1.6	А
Drain peak current	I <sub>D(pulse)</sub> Note1	-4.0	А
Body - drain diode reverse drain current	I <sub>DR</sub>	-1.6	А
Channel dissipation	Pch Note2	0.8	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. When using the glass epoxy board (FR-4: 40 x 40 x 1 mm)

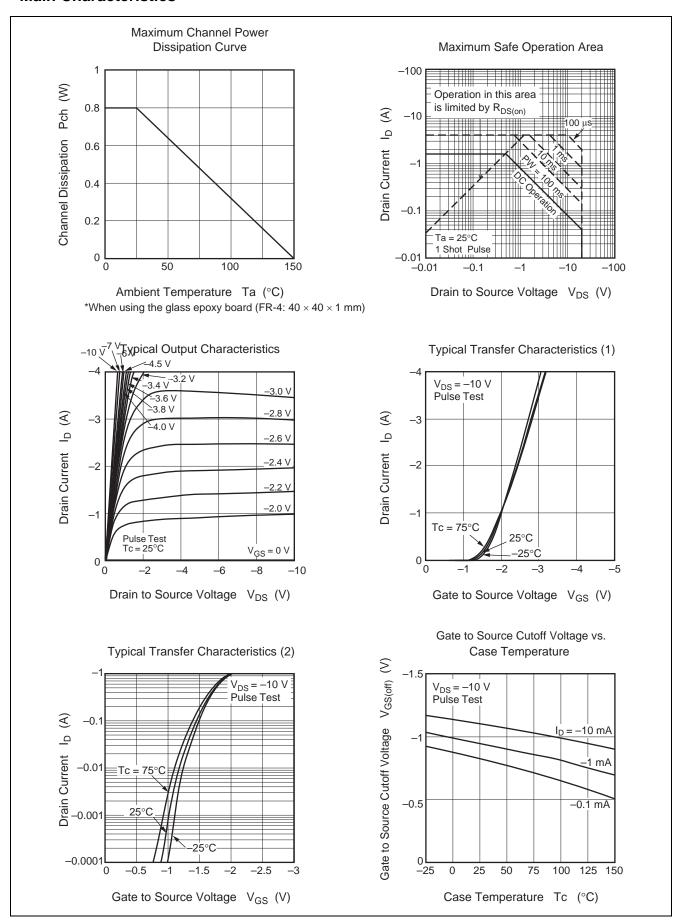
# **Electrical Characteristics**

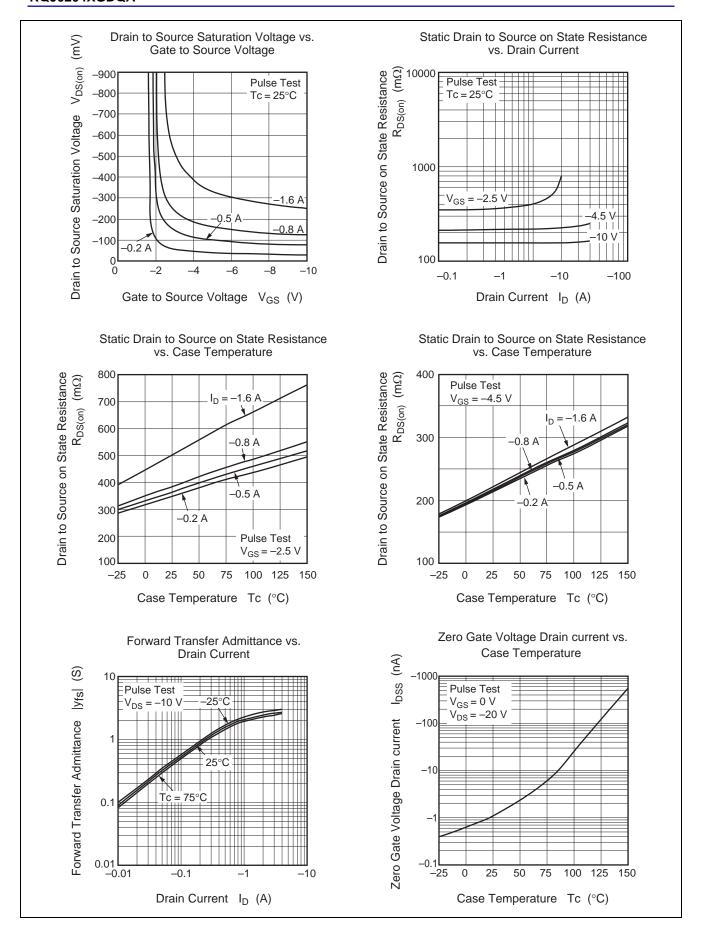
 $(Ta = 25^{\circ}C)$ 

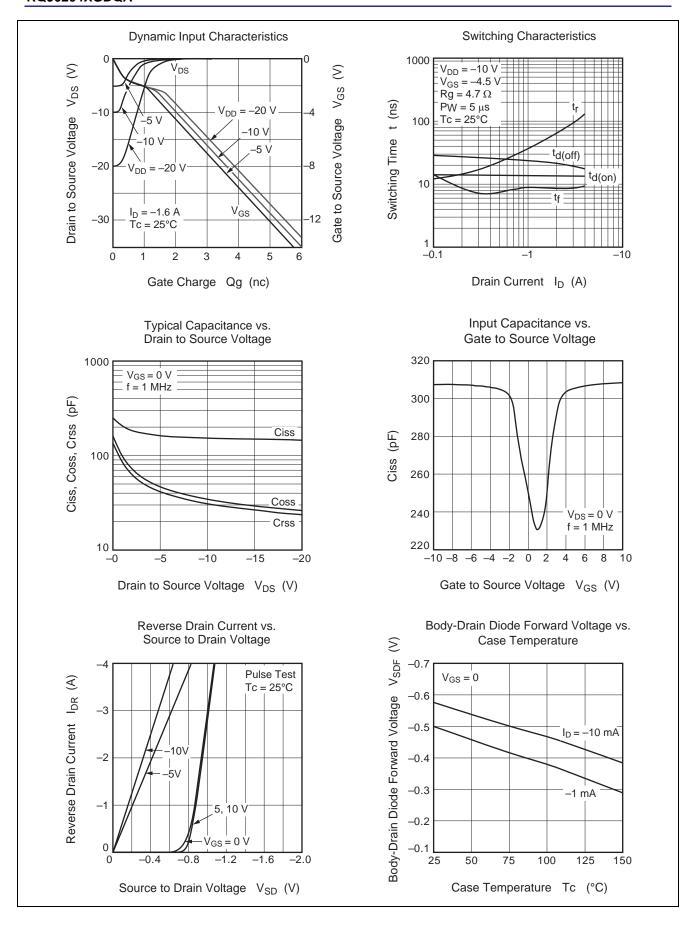
Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source breakdown voltage	$V_{(BR)DSS}$	-20	_	_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$	
Gate to source breakdown voltage	$V_{(BR)GSS}$	+8	_	_	V	$I_G = +100 \mu A, V_{DS} = 0$	
	V <sub>(BR)GSS</sub>	-12	_	_	V	$I_G = -100 \mu A, V_{DS} = 0$	
Gate to source leak current	I <sub>GSS</sub>		_	+10	μΑ	$V_{GS} = +6 \text{ V}, V_{DS} = 0$	
	I <sub>GSS</sub>	_	_	-10	μΑ	$V_{GS} = -10 \text{ V}, V_{DS} = 0$	
Drain to source leak current	I <sub>DSS</sub>	_	_	-1	μΑ	$V_{DS} = -20 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	-0.4	_	-1.4	V	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	
Drain to source on state resistance	R <sub>DS(on)</sub>	_	219	280	mΩ	$I_D = -0.8 \text{ A}, V_{GS} = -4.5 \text{ V}^{\text{Note3}}$	
	R <sub>DS(on)</sub>	_	363	510	mΩ	$I_D = -0.8 \text{ A}, V_{GS} = -2.5 \text{ V}^{\text{Note3}}$	
Forward transfer admittance	y <sub>fs</sub>	1.3	1.9	_	S	$I_D = -0.8 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note3}}$	
Input capacitance	Ciss	_	153	_	pF	V <sub>DS</sub> = -10 V	
Output capacitance	Coss	_	37	_	pF	$V_{GS} = 0$	
Reverse transfer capacitance	Crss	_	31	_	pF	f = 1 MHz	
Turn - on delay time	t <sub>d(on)</sub>	_	14	_	ns	$I_D = -0.8 \text{ A}$	
Rise time	t <sub>r</sub>	_	33	_	ns	$V_{GS} = -4.5 \text{ V}$	
Turn - off delay time	$t_{d(off)}$	_	24	_	ns	$R_L = 12.5 \Omega$	
Fall time	t <sub>f</sub>	_	8	_	ns	$Rg = 4.7 \Omega$	
Total gate charge	Qg	_	2.2	_	nC	$V_{DD} = -10 \text{ V}$	
Gate to source charge	Qgs	_	0.5	_	nC	$V_{GS} = -4.5 \text{ V}$	
Gate to drain charge	Qgd	_	0.9	_	nC	$I_D = -1.6A$	
Body - drain diode forward voltage	$V_{DF}$	_	-0.85	-1.1	V	$I_F = -1.6 \text{ A}, V_{GS} = 0^{\text{Note3}}$	

Notes: 3. Pulse test

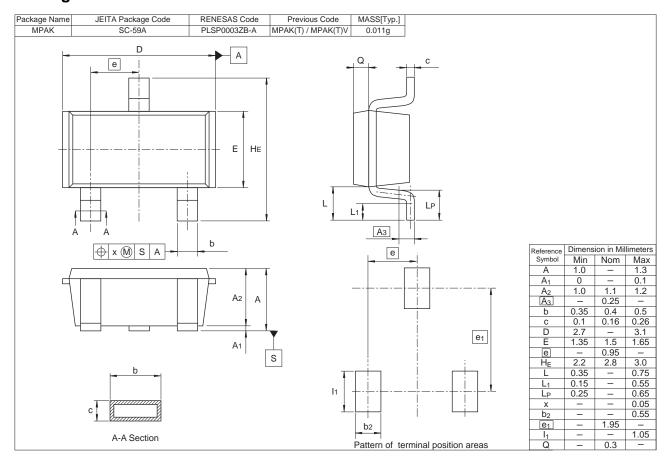
## **Main Characteristics**







## **Package Dimensions**



# **Ordering Information**

Orderable Part Number	Quantity	Shipping Container
RQJ0204XGDQATL-H	3000 pcs.	φ178 mm reel, 8 mm Emboss taping

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